

N-Channel 100-V (D-S) MOSFET

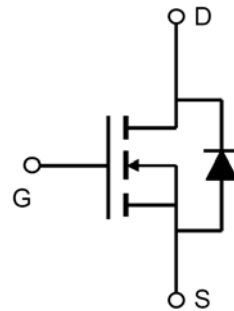
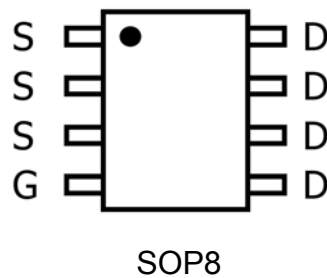
● FEATURES

V_{DS}	100V
I_D ($V_{GS}=10V$)	3.6A
$R_{DS(ON)}$ ($V_{GS}=10V$)	<120m Ω
$R_{DS(ON)}$ ($V_{GS} = 4.5V$)	<145m Ω

● GENERAL DESCRIPTION

The FS4460 combines advanced trench MOSFET technology with a low resistance package to provide extremely low $R_{DS(ON)}$. This device is ideal for load switch and battery protection applications.

● PIN CONFIGURATION



● Absolute Maximum Ratings ($T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter		Symbol	Maximum	Units
Drain-Source Voltage		V_{DS}	100	V
Gate-Source Voltage		V_{GS}	± 20	V
Continuous Drain Current	$T_A=25^\circ\text{C}$	I_D	3.6	A
	$T_A=70^\circ\text{C}$		2.9	
Pulsed Drain Current ^C		I_{DM}	14	
Avalanche Current ^C		I_{AS}, I_{AR}	22	A
Avalanche energy $L=0.1\text{mH}$ ^C		E_{AS}, E_{AR}	18	mJ
Power Dissipation ^B	$T_A=25^\circ\text{C}$	P_D	3.1	W
	$T_A=70^\circ\text{C}$		2	
Junction and Storage Temperature Range		T_J, T_{STG}	-55 to 150	$^\circ\text{C}$

● **Electrical Characteristics** ($T_J=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
STATIC PARAMETERS						
BV_{DSS}	Drain-Source Breakdown Voltage	$I_D=250\mu\text{A}, V_{GS}=0\text{V}$	100			V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=100\text{V}, V_{GS}=0\text{V}$			1	μA
I_{GSS}	Gate-Body leakage current	$V_{DS}=0\text{V}, V_{GS}=\pm 20\text{V}$			± 100	nA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	1		3	V
$R_{DS(on)}$	Static Drain-Source On-Resistance	$V_{GS}=10\text{V}, I_D=3.6\text{A}$		95	120	m Ω
		$V_{GS}=4.5\text{V}, I_D=3.6\text{A}$		110	145	
V_{SD}	Diode Forward Voltage	$I_S=2.3\text{A}, V_{GS}=0\text{V}$		0.8	1.2	V
DYNAMIC PARAMETERS						
C_{iss}	Input Capacitance	$V_{GS}=0\text{V}, V_{DS}=15\text{V}, f=1\text{MHz}$		905		pF
C_{oss}	Output Capacitance			145		
C_{rss}	Reverse Transfer Capacitance			43		
R_g	Gate resistance	$V_{GS}=0\text{V}, V_{DS}=0\text{V}, f=1\text{MHz}$		1		Ω
SWITCHING PARAMETERS						
Q_g	Total Gate Charge	$V_{GS}=10\text{V}, V_{DS}=80\text{V}, I_D=2.5\text{A}$		24		nC
Q_g	Total Gate Charge	$V_{GS}=4.5\text{V}, V_{DS}=80\text{V}, I_D=2.5\text{A}$		14		
Q_{gs}	Gate Source Charge			3.8		
Q_{gd}	Gate Drain Charge			7.5		
$t_{D(on)}$	Turn-On Delay Time	$V_{DD}=50\text{V}, R_L=10\Omega, I_D=1\text{A}, V_{GEN}=10\text{V}, R_G=6\Omega$		15		ns
t_r	Turn-On Rise Time			8		
$t_{D(off)}$	Turn-Off Delay Time			47		
t_f	Turn-Off Fall Time			6		

A. The value of $R_{\theta JA}$ is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^\circ\text{C}$. The value in any given application depends on the user's specific board design.

B. The power dissipation P_D is based on $T_{J(MAX)}=150^\circ\text{C}$, using $\leq 10\text{s}$ junction-to-ambient thermal resistance.

C. Repetitive rating, pulse width limited by junction temperature $T_{J(MAX)}=150^\circ\text{C}$. Ratings are based on low frequency and duty cycles to keep initial $T_J=25^\circ\text{C}$.

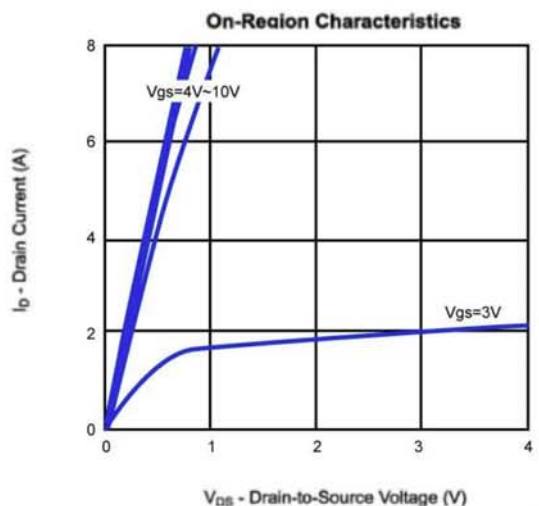
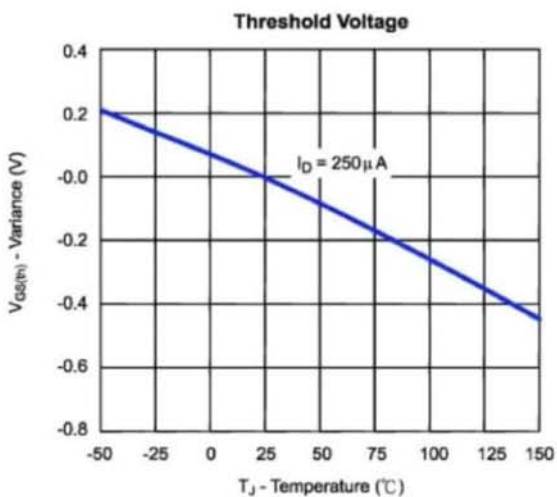
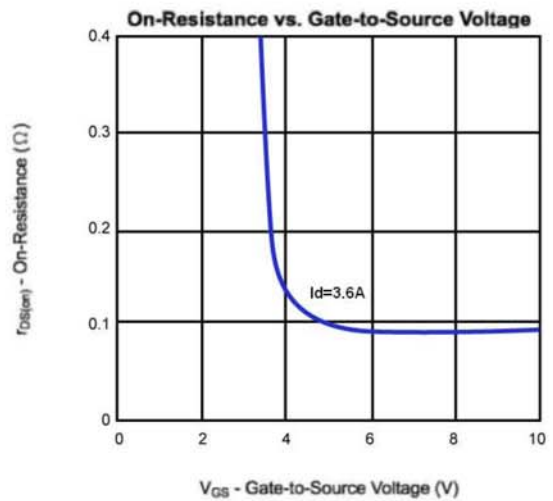
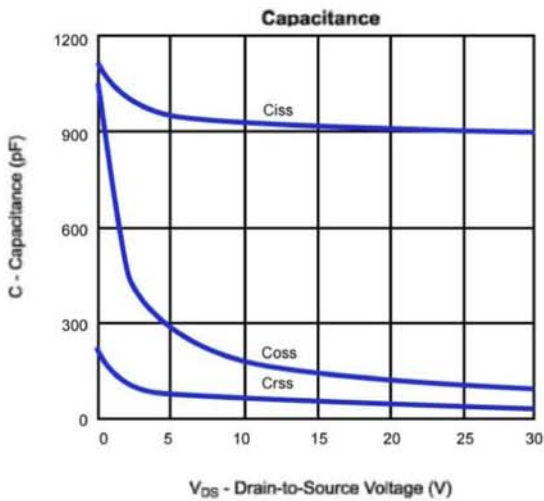
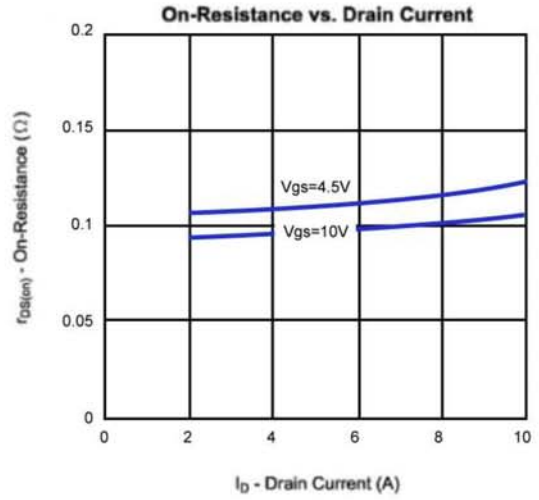
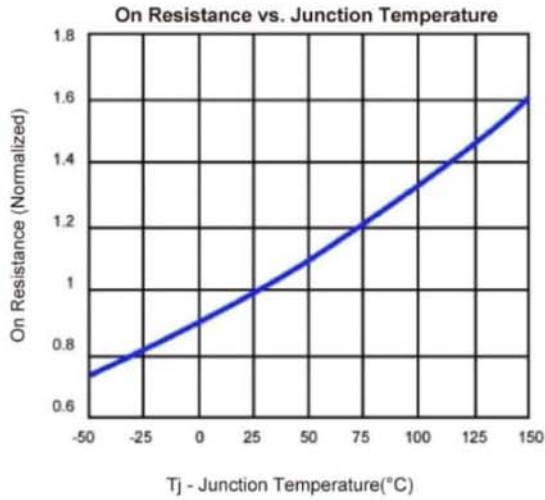
D. The $R_{\theta JA}$ is the sum of the thermal impedance from junction to lead $R_{\theta JL}$ and lead to ambient.

E. The static characteristics in Figures 1 to 6 are obtained using $<300\mu\text{s}$ pulses, duty cycle 0.5% max.

F. These curves are based on the junction-to-ambient thermal impedance which is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, assuming a maximum junction temperature of $T_{J(MAX)}=150^\circ\text{C}$. The SOA curve provides a single pulse rating.

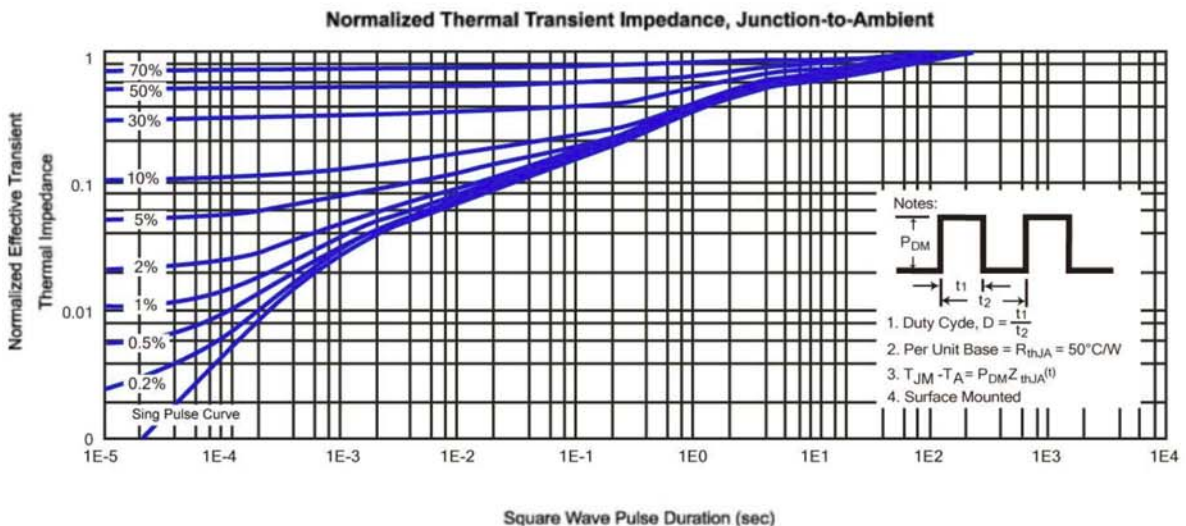
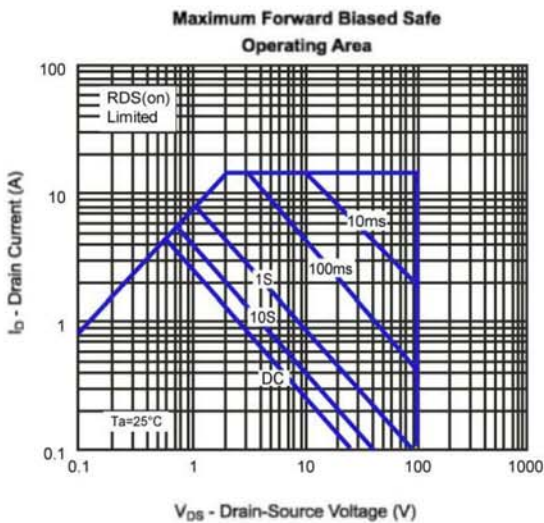
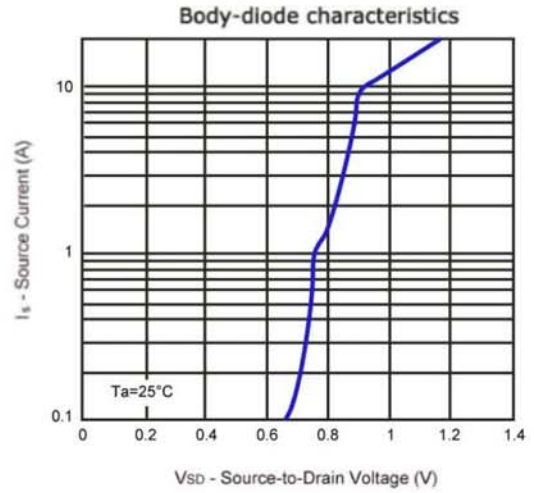
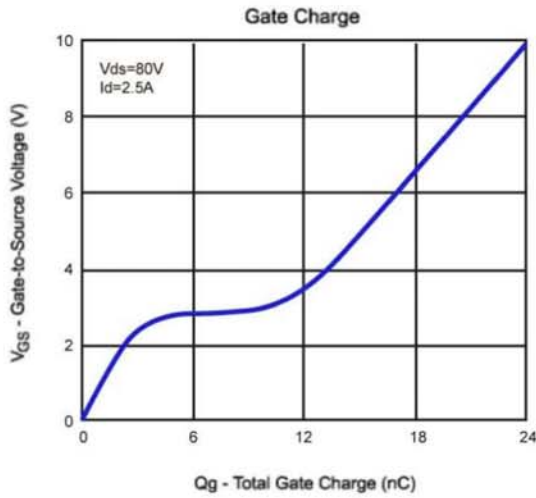


● TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS





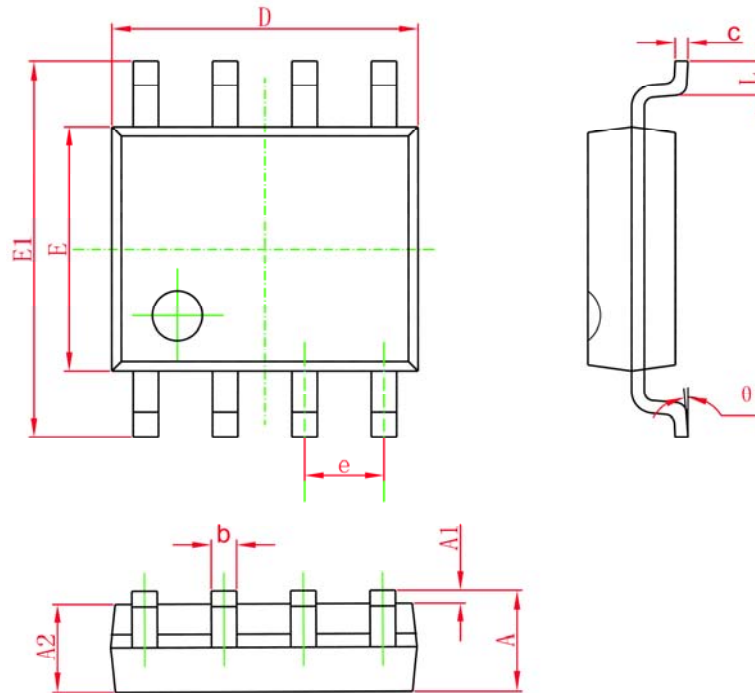
● TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS





● Package Information

SOP8



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.006	0.010
D	4.700	5.100	0.185	0.200
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.270(BSC)		0.050(BSC)	
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°